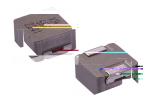


#### **MDA HT Series**

# SMD Low Profile High Current Molded Inductor Size 1365

#### **FEATURES**

Ultra low buzz noise, due to composite construction .



AEC-Q200 qualified.

Operating temperature: -55 to +155 °C (including self-temperature rise)

Quantity: 500PCS

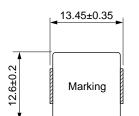
#### **APPLICATION**

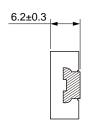
Headlamps, tail lamps and interior lighting

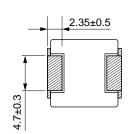
Doors, window lift and seat control

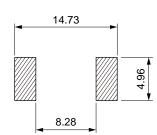
In-Vehicle Infotainment and navigation

Dimensions: [mm]









Land Pattern: [mm]

## **Electrical Properties:**

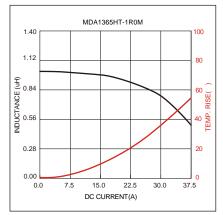
T	T .		

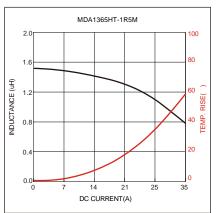
Saturation Current will cause L to drop approximately 30%.

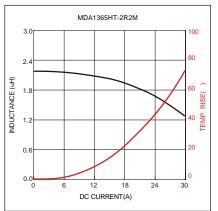
Temperature Rise Current: The actual value of DC current when the temperature rise is T=40°C

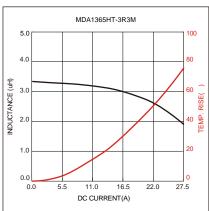


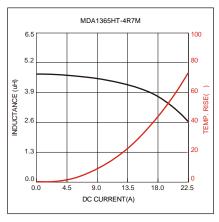
## Typical Electrical Characteristics:

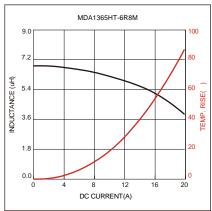


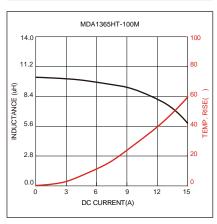


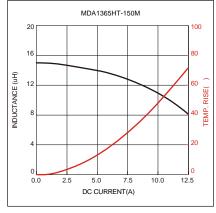


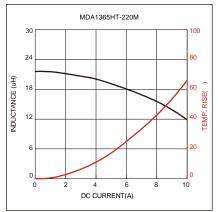


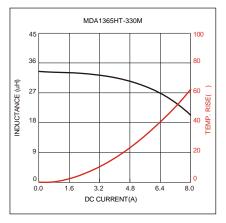


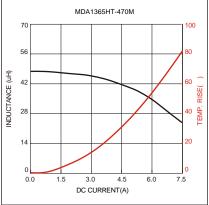






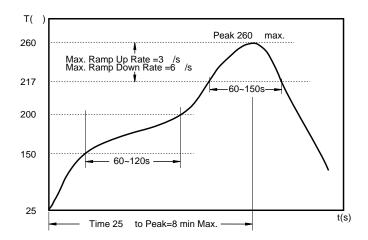








## Soldering Reflow:



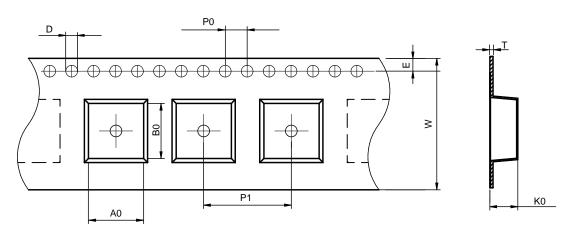
Preheat condition: 150 ~200 / 60~120 sec.

Allowed time above 217 : 60~150 sec.

Max temperature: 260 .
Allowed Reflow time: 2x max.

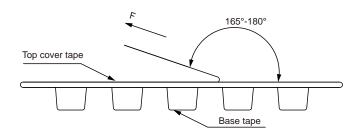
## Packaging Information:

## Tape Dimension:



Series	A0	B0	D	P0	P1	W	K0	E	T
	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)
MDA1365HT	13.1±0.1	14.0±0.1	1.5±0.1	4.0±0.1	16±0.1	24±0.3	6.7±0.1	1.75±0.1	0.50±0.05

#### Peel force of top cover tape:

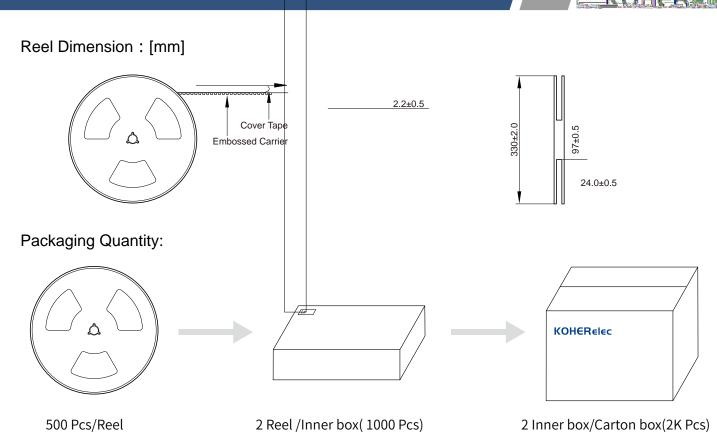


The peel force of top cover tape shall be between 0.1 to 1.3 N

## **Product Marking:**

Marking	KH+Printing (Inductance+period)
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### Cautions and Warnings:

#### Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

#### **Operation Instructions:**

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer
  does.As a result customer shall be responsible for checking and confirming whether Koher product with the
  performance described in the product specification is suitable for using in customer's particular application or
  not.